MOSFET – Small Signal, Complementary with ESD Protection, SOT-563

20 V, 540 mA / -430 mA

Features

- Leading Trench Technology for Low RDS(on) Performance
- High Efficiency System Performance
- Low Threshold Voltage
- ESD Protected Gate
- Small Footprint 1.6 x 1.6 mm
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- DC-DC Conversion Circuits
- Load/Power Switching with Level Shift
- Single or Dual Cell Li-Ion Battery Operated Systems
- High Speed Circuits
- Cell Phones, MP3s, Digital Cameras, and PDAs

MAXIMUM RATINGS (T, I = 25°C unless otherwise specified)

Para	Symbol	Value	Unit			
Drain-to-Source Voltaç	V_{DSS}	20	V			
Gate-to-Source Voltag	Gate-to-Source Voltage					
N-Channel Continu-	Steady	$T_A = 25^{\circ}C$		540		
ous Drain Current (Note 1)	State	T _A = 85°C		390		
	t ≤ 5 s	T _A = 25°C		570	m ^	
P-Channel Continu-	Steady	T _A = 25°C	I _D	-430	mA	
ous Drain Current (Note 1)	State	T _A = 85°C		-310		
	t ≤ 5 s	T _A = 25°C		-455		
Power Dissipation	Steady	T _A = 25°C	P _D	250		
(Note 1)	State				mW	
	t ≤ 5 s			280		
Pulsed Drain Current	N-Channel	t = 10 us	1	1500	mA	
	P-Channel	t _p = 10 μs	I _{DM}	-750	IIIA	
Operating Junction and	T _J ,	-55 to	°C			
	T _{STG}	150				
Source Current (Body [I _S	350	mA			
Lead Temperature for S (1/8" from case for 1	TL	260	°C			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using 1 in sq. pad size (Cu area = 1.127 in sq [1 oz] including traces).

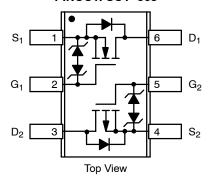


ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max (Note 1)
	0.4 Ω @ 4.5 V	
N-Channel 20 V	0.5 Ω @ 2.5 V	540 mA
20 •	0.7 Ω @ 1.8 V	
2	0.5 Ω @ -4.5 V	
P-Channel -20 V	0.6 Ω @ -2.5 V	–430 mA
10.	1.0 Ω @ -1.8 V	

PINOUT: SOT-563





TW = Specific Device Code

M = Date Code ■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]	
NTZD3155CT1G	SOT-563 (Pb-Free)	4000 / Tana & Daa	
NTZD3155CT2G		4000 / Tape & Reel	
NTZD3155CT5G		8000 / Tape & Reel	

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Thermal Resistance Ratings

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 2)	$R_{ heta JA}$	500	°C/W
Junction-to-Ambient - t = 5 s (Note 2)		447	

^{2.} Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

ELECTRICAL CHARACTERISTICS (T₁ = 25°C unless otherwise specified)

Parameter	Symbol	N/P	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							-	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	N	V _{GS} = 0 V	I _D = 250 μA	20			V
		Р		I _D = -250 μA	-20			
Drain-to-Source Breakdown Voltage Temperature Coefficient	V(_{BR)DSS} /T _J					18		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	N	V _{GS} = 0 V, V _{DS} = 16 V	T _J = 25°C			1.0	μΑ
		Р	$V_{GS} = 0 \text{ V}, V_{DS} = -16 \text{ V}$				-1.0	
		N	V _{GS} = 0 V, V _{DS} = 16 V	T _J = 125°C			2.0	μΑ
		Р	V _{GS} = 0 V, V _{DS} = - 16V	1			-5.0	
Gate-to-Source Leakage Current	I _{GSS}	Р	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$				±2.0	μΑ
		N					±5.0	
ON CHARACTERISTICS (Note 3)							-	
Gate Threshold Voltage	V _{GS(TH)}	N	$V_{GS} = V_{DS}$	I _D = 250 μA	0.45		1.0	V
		Р		I _D = -250 μA	-0.45		-1.0	
Gate Threshold Temperature Coefficient	V _{GS(TH)} /T _J					-1.9		-mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	N	$V_{GS} = 4.5 \text{ V}, I_D = 540 \text{ mA}$ $V_{GS} = -4.5 \text{V}, I_D = -430 \text{ mA}$ $V_{GS} = 2.5 \text{ V}, I_D = 500 \text{ mA}$			0.4	0.55	
		Р				0.5	0.9	
		N				0.5	0.7	
		Р	$V_{GS} = -2.5V, I_D = -2.5V$	-300 mA		0.6	1.2	Ω
		N	V _{GS} = 1.8 V, I _D = 3	350 mA		0.7	0.9	
		Р	V _{GS} = -1.8V, I _D = -	-150 mA		1.0	2.0	
Forward Transconductance	9 _{FS}	N	V _{DS} = 10 V, I _D = 5	540 mA		1.0		
		Р	V _{DS} = -10 V, I _D = -430 mA			1.0		S
CHARGES, CAPACITANCES AND GA	ATE RESISTAN	ICE						
Input Capacitance	C _{ISS}					80	150	
Output Capacitance	C _{OSS}	N	f = 1 MHz, V _{GS} V _{DS} = 16 V	= 0 V /		13	25	7
Reverse Transfer Capacitance	C _{RSS}	1	VDS = 10 V			10	20	. –
Input Capacitance	C _{ISS}					105	175	pF
Output Capacitance	C _{OSS}	Р	$f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$ $V_{DS} = -16 \text{ V}$			15	30	
Reverse Transfer Capacitance	C _{RSS}	1				10	20	

^{3.} Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

	Symbol	N/P	Test Condition	on	Min	Тур	Max	Unit
CHARGES, CAPACITANCES AND	GATE RESIST	ANCE	1					
Total Gate Charge	Q _{G(TOT)}		N $V_{GS} = 4.5 \text{ V}, V_{DS} = -10 \text{ V}; I_D = 540 \text{ mA}$			1.5	2.5	
Threshold Gate Charge	Q _{G(TH)}	N				0.1		
Gate-to-Source Charge	Q_{GS}	1				0.2		
Gate-to-Drain Charge	Q_{GD}	1				0.35		0
Total Gate Charge	Q _{G(TOT)}		$V_{GS} = -4.5 \text{ V}, V_{DS} = 10 \text{ V}; I_{D} = -380 \text{ mA}$			1.7	2.5	nC
Threshold Gate Charge	Q _{G(TH)}	P				0.1		
Gate-to-Source Charge	Q_{GS}	7				0.3		
Gate-to-Drain Charge	Q_{GD}					0.4		
SWITCHING CHARACTERISTICS	(V _{GS} = V) (Not	e 4)						
Turn-On Delay Time	t _{d(ON)}	N	V_{GS} = 4.5 V, V_{DD} = -10 V, I_{D} = 540 mA, R_{G} = 10 Ω			6.0		
Rise Time	t _r					4.0		
Turn-Off Delay Time	t _{d(OFF)}	1				16		
Fall Time	t _f	1				8.0		
Turn-On Delay Time	t _{d(ON)}	Р				10		ns
Rise Time	t _r	1	V _{GS} = -4.5 V, V _{DD} = 10 V,	I _D = -215 mA,		12		
Turn-Off Delay Time	t _{d(OFF)}	1	$R_G = 10 \Omega$			35		
Fall Time	t _f					19		
Drain-Source Diode Characterist	tics							
Forward Diode Voltage	V _{SD}	N	V 0V T 050C	I _S = 350 mA		0.7	1.2	\/
		Р	$V_{GS} = 0 \text{ V, } T_{J} = 25^{\circ}\text{C}$	$I_{S} = -350 \text{ mA}$		-0.8	-1.2	V
Reverse Recovery Time	t _{RR}	N	$V_{GS} = 0 \text{ V},$	I _S = 350 mA		6.5		
		Р	dIS/dt = 100 A/μs	$I_{S} = -350 \text{ mA}$		13		ns

^{4.} Switching characteristics are independent of operating junction temperatures

N-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

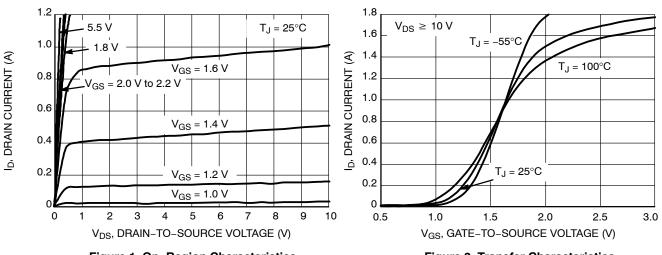


Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics

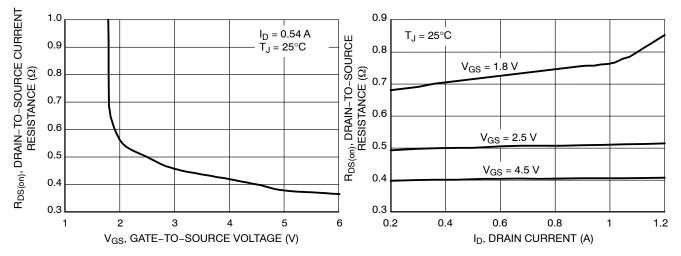


Figure 3. On-Resistance versus Gate-to-Source Voltage

Figure 4. On-Resistance versus Drain Current and Gate Voltage

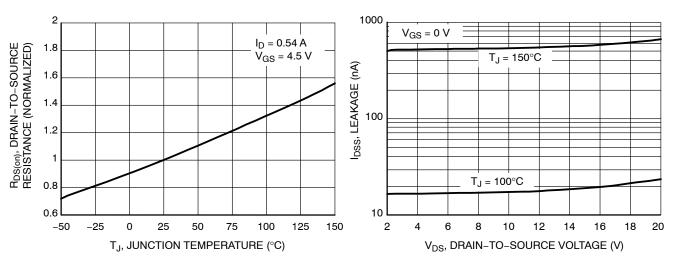


Figure 5. On–Resistance Variation with Temperature

Figure 6. Drain-to-Source Leakage Current versus Voltage

N-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

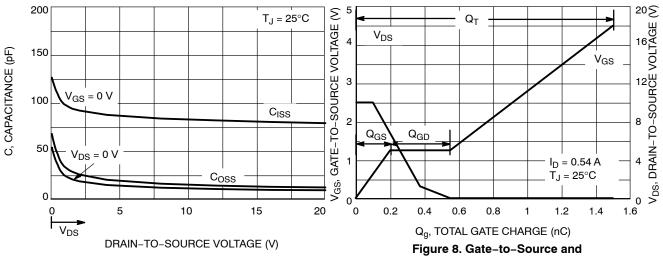


Figure 7. Capacitance Variation

Drain-to-Source Voltage versus Total Charge

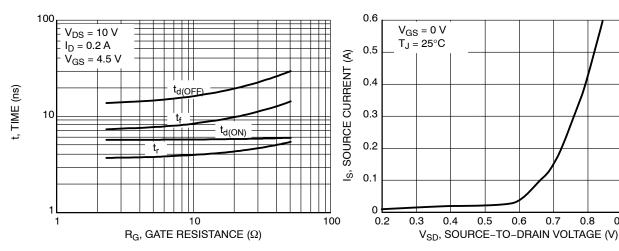


Figure 9. Resistive Switching Time Variation versus Gate Resistance

Figure 10. Diode Forward Voltage versus Current

0.7

0.8

P-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

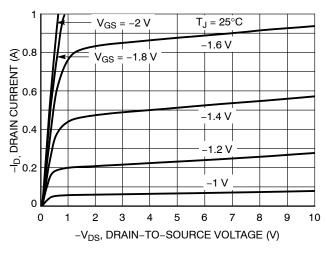


Figure 1. On-Region Characteristics

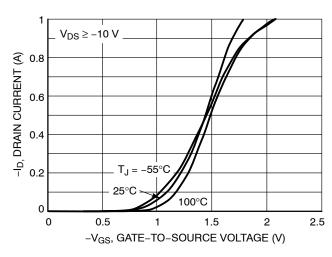


Figure 2. Transfer Characteristics

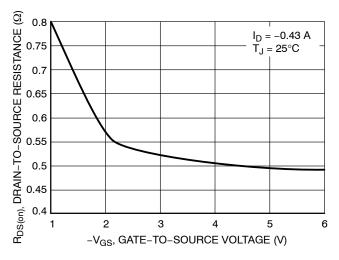


Figure 3. On-Resistance vs. Gate-to-Source Voltage

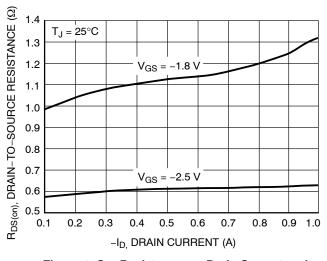


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

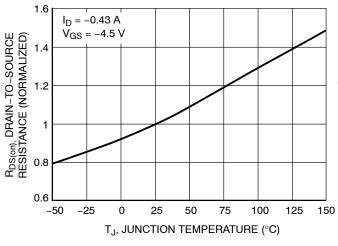


Figure 5. On–Resistance Variation with Temperature

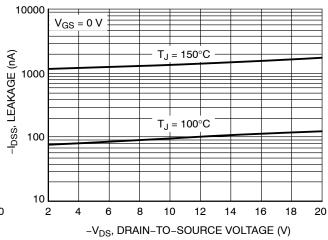


Figure 6. Drain-to-Source Leakage Current vs. Voltage

P-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

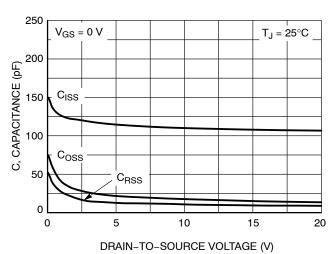
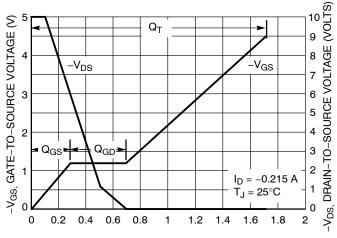


Figure 7. Capacitance Variation



Q_G, TOTAL GATE CHARGE (nC)

Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

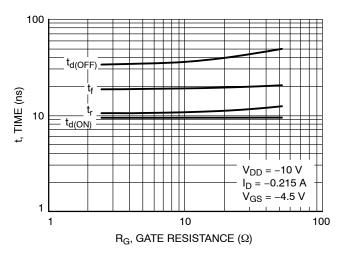


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

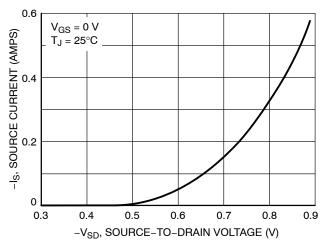


Figure 10. Diode Forward Voltage vs. Current

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



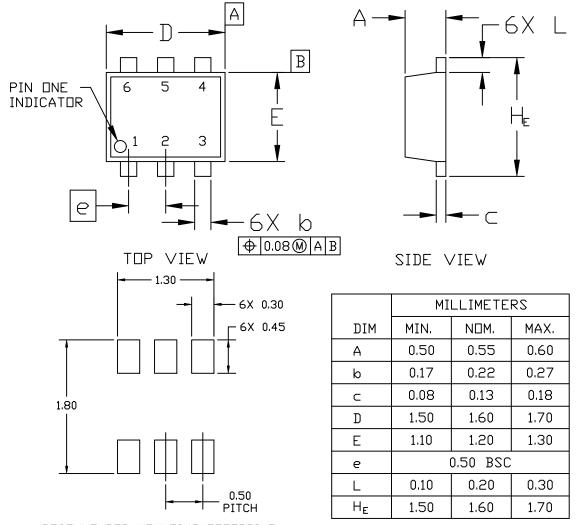


SOT-563, 6 LEAD CASE 463A ISSUE H

DATE 26 JAN 2021

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.



RECOMMENDED MOUNTING FOOTPRINT*

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

DOCUMENT NUMBER:	98AON11126D	Electronic versions are uncontrolled except when accessed directly from the Document Re Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOT-563, 6 LEAD		PAGE 1 OF 2	

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

SOT-563, 6 LEAD

CASE 463A ISSUE H

2

1

DATE 26 JAN 2021

STYLE 1: PIN 1. EMITTER 1 2. BASE 1 3. COLLECTOR 2 4. EMITTER 2 5. BASE 2 6. COLLECTOR 1	STYLE 2: PIN 1. EMITTER 1 2. EMITTER 2 3. BASE 2 4. COLLECTOR 2 5. BASE 1 6. COLLECTOR 1	STYLE 3: PIN 1. CATHODE 1 2. CATHODE 1 3. ANODE/ANODE 4. CATHODE 2 5. CATHODE 2 6. ANODE/ANODE
STYLE 4: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR	STYLE 5: PIN 1. CATHODE 2. CATHODE 3. ANODE 4. ANODE 5. CATHODE 6. CATHODE	STYLE 6: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE
STYLE 7: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. ANODE 6. CATHODE	STYLE 8: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SDURCE 5. DRAIN 6. DRAIN	STYLE 9: PIN 1. SDURCE 1 2. GATE 1 3. DRAIN 2 4. SDURCE 2 5. GATE 2 6. DRAIN 1
STYLE 10: PIN 1. CATHODE 1 2. N/C 3. CATHODE 2 4. ANODE 2 5. N/C 6. ANODE 1	STYLE 11: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	

GENERIC MARKING DIAGRAM*



XX = Specific Device CodeM = Month Code= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON11126D	Electronic versions are uncontrolled except when accessed directly from the Document Re Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOT-563, 6 LEAD		PAGE 2 OF 2	

ON Semiconductor and III are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B